

### General Description

This N-Channel MOSFET has been produced using advanced Power Trench technology to deliver low RDS(on) and optimized BVDSS capability to offer superior performance benefit in the application.

### Features

- 60A,40V.RDS(ON)=14Ω@VGS=10V
- Fast Switching
- N-channel-Enhancement mode
- 100% Avalanche Tested

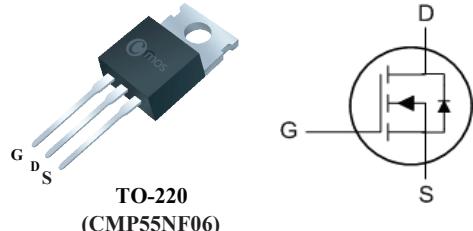
### Product Summary

BVDSS	RDSON	ID
40V	14mΩ	60A

### Applications

- Power Supplies
- DC-DC & DC-AC Converters
- Inverter

### TO-220 Pin Configuration



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current <sup>1</sup>	60	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	180	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	300	mJ
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	63	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Data

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	50	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	2	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=250\text{uA}$	40	---	---	V
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=28\text{A}$	---	---	14	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}$ , $\text{I}_D=25\text{A}$	---	---	17	
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$ , $\text{I}_D=250\text{uA}$	1	---	2.5	V
$\text{I}_{\text{DSS}}$	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=40\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$	---	---	1	$\text{uA}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 20\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$
$\text{g}_{\text{fs}}$	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}$ , $\text{I}_D=28\text{A}$	---	18	---	S
$\text{R}_g$	Gate Resistance	$\text{V}_{\text{DS}}=0\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	6	---	$\Omega$
$\text{Q}_g$	Total Gate Charge	$\text{I}_D=30\text{A}$ $\text{V}_{\text{DS}}=15\text{V}$ $\text{V}_{\text{GS}}=10\text{V}$	---	32	---	$\text{nC}$
$\text{Q}_{\text{gs}}$	Gate-Source Charge		---	3.5	---	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge		---	7.5	---	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=15\text{V}$ $\text{I}_D=30\text{A}$ $\text{R}_{\text{GEN}}=6\Omega$ $\text{V}_{\text{GS}}=10\text{V}$	---	20	---	$\text{ns}$
$\text{T}_r$	Rise Time		---	21	---	
$\text{T}_{\text{d(off)}}$	Turn-Off Delay Time		---	45	---	
$\text{T}_f$	Fall Time		---	15	---	
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{DS}}=20\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	1500	---	$\text{pF}$
$\text{C}_{\text{oss}}$	Output Capacitance		---	280	---	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	150	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{I}_s$	Continuous Source Current	$\text{V}_G=\text{V}_D=0\text{V}$ , Force Current	---	---	60	A
$\text{I}_{\text{SM}}$	Pulsed Source Current		---	---	180	A
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_s=28\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.5	V

Notes:

1. Surface Mounted on FR4 Board,  $t < 10\text{sec}$ .
2. Pulse Test: Pulse Width  $< 300\text{us}$ , Duty Cycle  $< 2\%$ .
3. Starting  $T_J = 25^\circ\text{C}$ ,  $L = 4\text{mH}$ ,  $\text{IAS} = 12.5\text{A}$ ,  $\text{VDD} = 20\text{V}$ ,  $\text{VGS} = 10\text{V}$ .

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